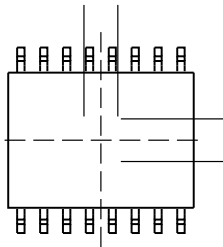
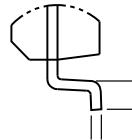
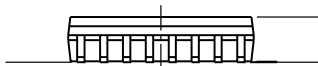
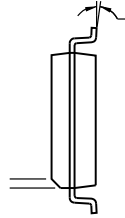
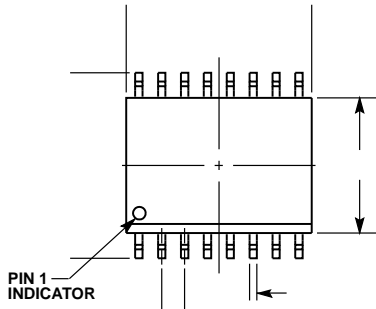


### SOIC-16 WB, EP



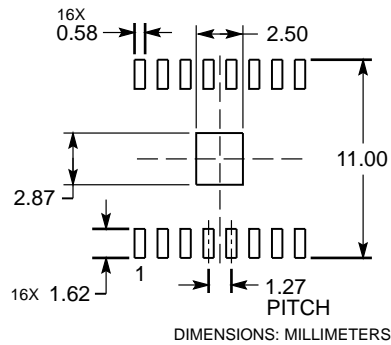
- NOTES:
1. DIMENSIONING AND TOLERANCING PER ASME Y14.5M, 1994.
  2. CONTROLLING DIMENSION: MILLIMETERS.
  3. DIMENSION b DOES NOT INCLUDE DAMBAR PROTRUSION. DAMBAR PROTRUSION SHALL BE 0.13 TOTAL IN EXCESS OF b DIMENSION AT MAXIMUM MATERIAL CONDITION.
  4. DIMENSIONS D AND E DO NOT INCLUDE MOLD PROTRUSIONS.
  5. MAXIMUM MOLD PROTRUSION OR FLASH TO BE 0.15 PER SIDE.

DIM	MILLIMETERS	
	MIN	MAX
A	2.3	2.6
A1	0.00	0.10
b	0.3	0.5
c	0.2	0.32
D	10.1	10.
D1	1.5	2.00
E	.0	6.0
E1	2.2	2.
e	1.2	
H	10.0	10.
h	0.3	
L	0.0	0.0
M	0°	0°

### GENERIC MARKING DIAGRAM\*

XXXXXXXXXX  
 XXXXXXXXXXXX  
 XXXXXXXXXXXX  
 AWLYYWWG

### RECOMMENDED SOLDERING FOOTPRINT



\*This information is generic. Please refer to device data sheet for actual part marking. Pb-Free indicator, "G" or microdot "▪", may or may not be present.